APPROVAL SHEET

MODEL NO: COG-T430M	<u>INI-27P</u>	Allen 1
Approval option:	☐ Specification	
	□ Sample	. 18th
■ Customer's Confirma	tion	XX AN
Customer :	() 11	
Approved by: Date:	水料	
Note:	2 XIII 1	
■ Center Confirmed:		
Approved	Checked by	Made by

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1. Introduction

1.1 Scope of application

This specification applies to the Negative type TFT transmissive dot matrix LCD module.

LCD specification: Dots 480xRGBx272.

As to basic specification of the driver IC, refer to the IC (ILI6480BQ) specification and data sheet.

1.2 Structure:

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Double display structure:

TFT Module + FPC +BL+TP;

FULL 16.7M Colors 4.3 inch TFT LCD size for main LCD;

One bare chip with gold bump (COG) TECH;

24 BITS RGB interface;
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1.3 TFT features:

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Structure: TFT PANNEL+IC+FPC+BL;
Transmissive Type LCD;
480 dot-source and 272 dot-gate outputs;
16.7M Color;
White LED back light;
24 BITS RGB interface;
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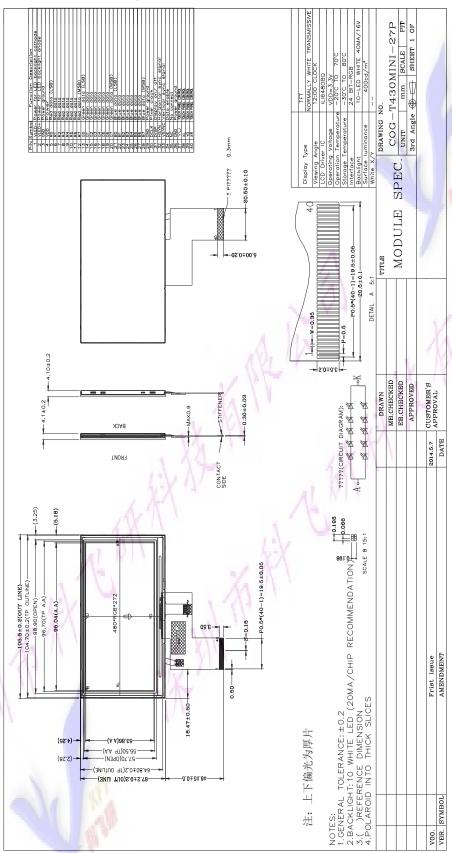
1.4 Applications:

Mobile phone PSP PDA GPS

2. General specification

ITEM	Standard value	UNIT
LCD Type	TFT Transmissive Normal White	
Driver element	a-Si TFT Active matrix	
Number of Dots	480* (RGB) *272	Dots
Pixel Arrangement	RGB Vertical Stripe	Λ
Active Area	95. 04x53. 86	mm
Viewing Direction	12 O' clock	01
Driver IC	ILI6480BQ	
Module Size(W*H*T)	67. 2x105. 5x4. 7	mm
Approx. Weight	TBD	g
Back Light	White LED	
System interface	24 BITS RGB interface	

3. Mechanical drawing



4. Absolute Maximum Ratings

Parameter	Symbol	Min	Max	Unit
Supply voltage for logic	$V_{\scriptscriptstyle DD}$	-0. 5	5. 0	V
Input voltage for logic	$ m V_{_{IN}}$	VSS-0.5	$V_{\scriptscriptstyle DD}$	v
Supply current (One LED)	${ m I}_{\scriptscriptstyle m LED}$		30	mA A
Operating temperature	T_{0P}	-20	+70	°C
Storage temperature	T_{ST}	-30	+80	$^{\circ}$ C

Note: The absolute maximum rating values of this product are not allowed to be exceeded at any times. Should a module be used with any of the absolute maximum ratings exceeded, the characteristics of the module may not be recovered, or in an extreme case, the module may be permanently destroyed.

5. Operating Specifications

5.1. Electrical Characteristics

Item	Symbol	Min	Тур	Max	Unit	Applicable terminal
Supply voltage for logic	$V_{ m DD}$	3.0	3. 3	3.6	V	$V_{\scriptscriptstyle DD}$
Input voltage	V_{IL}	VSS	124	0.3 V _{DD}	V	
Input voltage	V _{IH}	0.7V _{DD}	17+1	V_{DD}	V	
Input current	$I_{ exttt{DD}}$	7.1	TBD	_	mA	
LED Forward voltage	$V_{\rm f}$	3. 0	3. 2	3. 4	V	
Input backlight current	${ m I}_{\scriptscriptstyle m LED}$	71	20	25	mA	With One LED



5.2. Backlight Driving Conditions

Item	Symbol		Values		Unit	Remark
item	Symbol	Min.	Тур.	Max.	Ome	Kemark
Voltage for LED backlight	$V_{\rm L}$	15	16	17	V	Note 1
Current for LED backlight	$I_{\rm L}$	18	40	25	mA	1
LED life time	-	20,000	-	-	Hr	Note 2

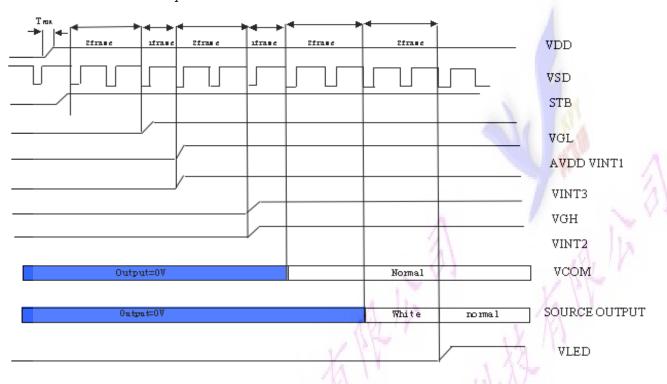
Note 1: The LED Supply Voltage is defined by the number of LED at Ta=25°C and I_L =40mA. Note 2: The "LED life time" is defined as the module brightness decrease to 50% original brightness at Ta=25°C and I_L =40mA. The LED lifetime could be decreased if operating I_L is lager than 40 mA.

5.3. Power Sequence

5.3.1. power off sequence



5.3.2. Power on sequence



5.4 Touch panel specifications

5.4.1 Electrical Characteristics

ITEM	SPECIFICATION S			UNIT	DEMADIZ		
	MIN .	TYP.	MA X	UNII	REMARK		
Linearity	-1.5	-	1.5	%	After environment & life test		
Terminal Resistance	400	-	1050	ohm	X(Film side)		
Terrimar Resistance	100	-	450	ohm	Y(Glass side)		
Insulation Resistance	20	-	-	Mohm	DC 25V 1min		
Operating Voltage	-	-	10	V	DC		

5.4.2 Optical Characteristics

ITEM	SPEC	CIFICA S	TION	LINIT	REMARK		
ITEM	MIN .	TYP.	MA X	UNIT			
Response Time	-	-	10	ms	100kohm pull-up		
Light Transparency	80	- 17	1/4 1	%	.1 17		

5.4.3 Mechanical Characteristics

ITEM	SPE	CIFICATI	UNI	REMARK		
	MIN.	TYP.	MAX	T	KEWIAKK	
Operation Force	- XV	110	/ [gf	Note1	
Surface Hardness	3	-	, , , , ,	Н		
Pen Sliding Durability	100,000		V-X	times	Note2	
Hitting Durability	1,000,000		11	times	Note3	

Note 1: Do not operate it with a thing except a polyacetal pen (tip R0.8mm or less) or a finger, especially those with hard or sharp tips such as a ball point pen or a mechanical pencil.

Depending on the pitch & the dimension of the spacer dots in between.

Note 2: Measurement for surface area.

-Scratch 100,000 times straight line on the film with a stylus change every 20,000 times.

-Force: 100gf. -Speed: 60mm/sec.

-Stylus: R0.8 polyacetal tip.

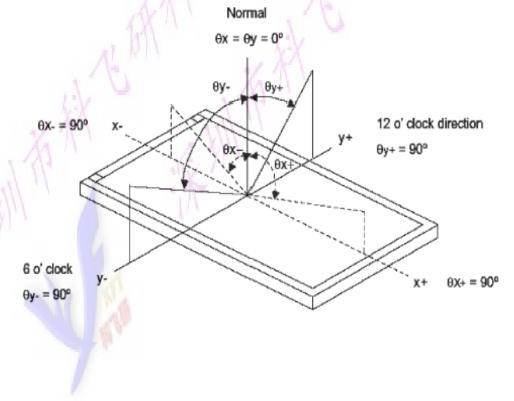
Note 3: Hit 1,000,000 times on the film with an R12.5mm tip.

-Force: 250gf. -Speed: 2 times/sec.

6. Optical Characteristics

ITEM		SYMBOL	CONDITIONS	SPE	CIFICAT	ONS	UNIT	NOTE
		SIMDOL	21MDOF COMPTITOM2		TYP.	MAX	UNII	NOIE
Brightness		В		360	400	_	Cd/m^2	
Contrast Rat	io	CR		400	500			
Response Tim	ie	Tr+Tf			25	30	ms	
	Red	X		0.551	0. 591	0.631		
Chamamatiai		Y	Viewing	0. 270	0.310	0.350	1	All left
Chromatici	Green	X	normal angle	0.302	0.342	0.382	1 4 4	side data
ty Coordinate		Y		0.516	0.561	0.601	7 6	are based on
(Transmiss	Blue	X		0. 105	0. 145	0. 185		Innolux's
ive)		Y		0.047	0.087	0. 127		product
1 ()	White	X		0. 260	0.280	0.300		reference
		Y		0.300	0.320	0.280	(1)	only
	Hor.	$\theta_{_{X+}}$		60	70		V	\
Viewing		$\theta_{\scriptscriptstyle X-}$	Center	60	70		301	
Angle	Ver.	$\theta_{\scriptscriptstyle{Y+}}$	CR>=10	40	50	-1,7	Deg.	
		$\theta_{\scriptscriptstyle Y-}$	Xa.	60	70	1 44	-	
Uniformity	Un		U M	80		LY Y	%	

Note 1 : Definition of Viewing Angle xand x:

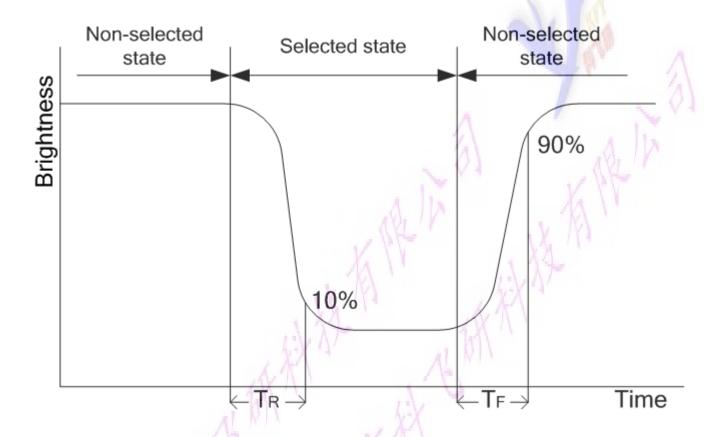


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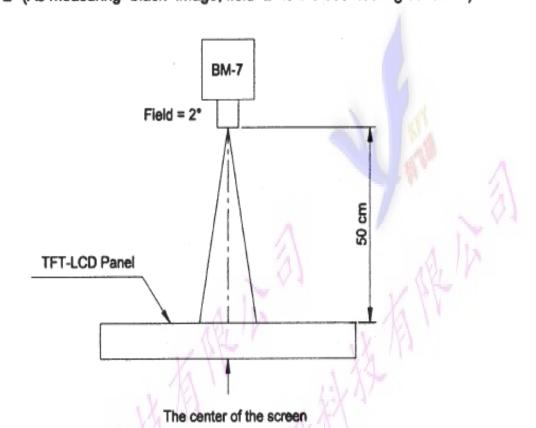
Note 2: Definition of contrast ratio CR:

CR= Brightness of non-selected dots (white)
Brightness of selected dots (black)

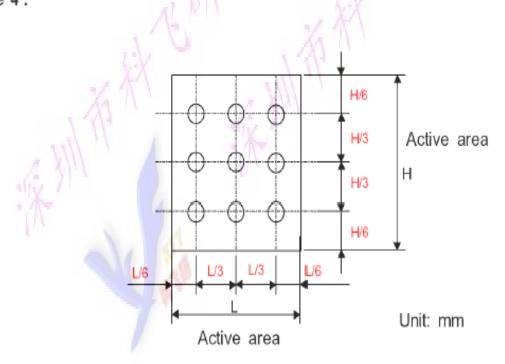
Note 3: Definition of response time (T_R, T_F)



: The brightness test equipment setup 20mA Field=2° (As measuring "black" image, field=2° is the best testing condition)



Note 4:



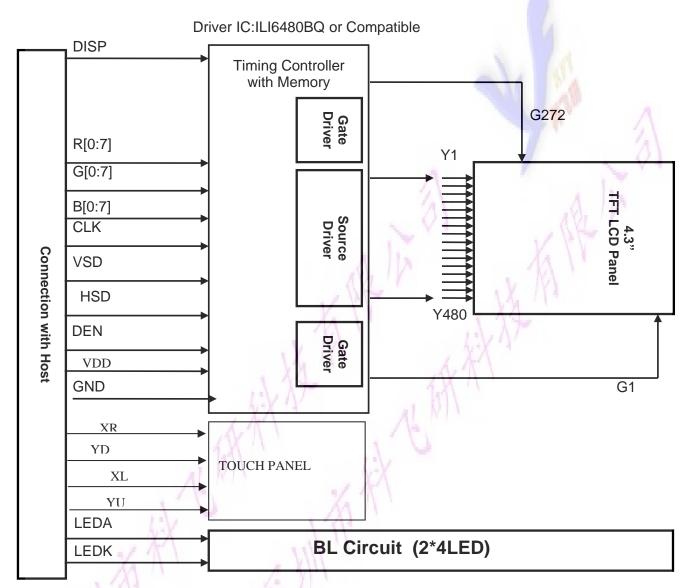
7. Pin Assignment

. Table 2: Pin assignment

Pin No.	Symbol	Description
1	VLED-	Cathode of LED backlight
2	VLED+	Anode of LED backlight
3	GND	Power ground
4	VDD	Power voltage
5	RO	Red data (LSB)
6	R1	Red data
7	R2	Red data
8	R3	Red data
9	R4	Red data
10	R5	Red data
11	R6	Red data
12	R7	Red data (MSB)
13	GO	Green data (LSB)
14	G1	Green data
15	G2	Green data
16	G3	Green data
17	G4	Green data
18	G5	Green data
19	G6	Green data
20	G7	Green data(MSB)
21	В0	Blue data(LSB)
22	B1	Blue data
23	B2	Blue data
24	В3	Blue data
25	В4	Blue data
26	B5	Blue data
27	В6	Blue data
28	В7	Blue data(MSB)
29	GND	Power ground
30	DCLK	Pixel clock
31	DISP	Display on/off
32	HSYN	Horizontal sync signal
33	VSYNC	Vertical sync signal
34	DE	Data enable
35	NC	NO connect
36	GND	Power ground
37	YU	TOUCH PANEL CONTROL
38	XL	TOUCH PANEL CONTROL

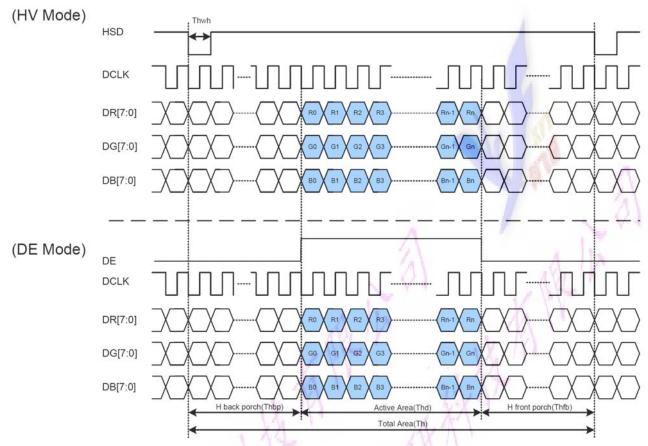
39	YD	TOUCH PANEL CONTROL
40	XR	TOUCH PANEL CONTROL

8. Block Diagram



9. Timing/Characteristics

9.1 Clock and data input time diagram



9.2 Parallel RGB input timing table

Parameter	Symbol	Min	Тур	Max	Unit
1.1.	à.	. 20			
DCLK frequence	Fclk	5	9	12	MZH
VSD period time	Tv	277	288	400	Н
VSD display area	Tvd	N.A	272		Н
VSD back porch	Tvb	3	8	31	Н
VSD front porch	Tvfp	2	8	97	Н
HSD period time	Th	520	525	800	DCLK
HSD display area	Thd		480		DCLK
HSD back porch	Thbp	36	40	255	DCLK
HSD front porch	Thfp	4	5	65	DCLK

10. Standard Specification for Reliability:

10 - 1.	Standard Specifications	for Reliability of LCD Module
No	Item	Description
01	High temperature operation	The sample should be allowed to stand at 70°C for 96 hours under driving condition and then returning it to normal temperature condition, and allowing it stand for 2 hours.
02	Low temperature operation	The sample should be allowed to stand at $-20^{\circ}\mathrm{C}$ for 96 hours under driving condition and then returning it to normal temperature condition, and allowing it stand for 2 hours.
03	High temperature storage	The sample should be allowed to stand at $80^\circ\!\!\mathrm{C}$ for 96 hours under no-load condition, and then returning it to normal temperature condition, and allowing it stand for 2 hours.
04	Low temperature storage	The sample should be allowed to stand at -30°C for 96 hours under no-load condition, then returning it to normal temperature condition, and allowing it stand for 2 hours.
05	Moisture storage	The sample should be allowed to stand at 60°C , $90\%\text{RH}$ MAX for 96 hours under no-load condition, then taking it out and drying it at normal temperature for 2 hours.
06	Thermal shock storage	The sample should be allowed to stand the following 10 cycles: -30°C for 30 minutes \rightarrow normal temperature for 5 minutes \rightarrow +80 $^{\circ}\text{C}$ for 30 minutes \rightarrow normal temperature for 5 minutes, as one cycle.
07	Packing vibration	Frequency range : 10Hz $^{\sim}$ 55Hz Amplitude of vibration : 1.5mm Sweep time: 12 min X, Y, Z 2 hours for each direction.
08	Packing drop test	According to ISTA 1A 2001.
09	Electrical Static Discharge	Air: $\pm 4 \text{KV} 150 \text{pF}/330 \Omega$ 5 times
	7	Contact: $\pm 2 \text{KV} 150 \text{pF}/330 \Omega$ 5 time

*Sample size for each test item is 3~5pcs

10 - 2. Testing Conditions and Inspection Criteria

For the final test the testing sample must be stored at room temperature for 24 hours, after the tests listed in Table 12.2, Standard specifications for Reliability have been executed in order to ensure stability.

No	Item	Test Model	In section Criteria
01	Current Consumption	Refer To Specification	The current consumption should conform to the product specification.
02	Contrast	Refer To Specification	After the tests have been executed, the contrast must be larger than half of its initial value prior to the tests.
03	Appearance	Visual inspection	Defect free.

10- 3. MTBF

	A A MI
MTBF	Functions, performance, appearance, etc. shall be free from remarkable deterioration within 10,000 hours under ordinary operating and storage conditions room temperature (25 \pm 5 °C), normal humidity (50 \pm 10% RH),
7/2 X	and in area not exposed to direct sun light.

11. Specification of Quality Assurance:

11-1. Purpose

This standard for Quality Assurance should affirm the quality of LCD module products to supply to purchaser by TeCenStar.

- 11-2. Standard for Quality Test
 - a. Inspection:

Before delivering, the supplier should take the following tests, and affirm the quality of product.

b. Electro-Optical Characteristics:

According to the individual specification to test the product.

c. Test of Appearance Characteristics:

According to the individual specification to test the product.

d. Test of Reliability Characteristics:

According to the definition of reliability on the specification for testing products.

e. Delivery Test:

Before delivering, the supplier should take the delivery test.

- (i) Test method: According to MIL-STD105E. General Inspection Level II take a single time.
- (ii) The defects classify of AQL as following:

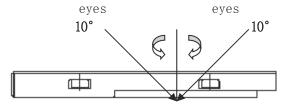
Major defect: AQL = 0.65 Minor defect: AQL = 2.5 Total defects: AQL = 2.5

- 11-3. Non-conforming Analysis & Deal With Manners
 - a. Non-conforming Analysis:
 - (i) Purchaser should supply the detail data of non-conforming sample and the non-conforming.
 - (ii) After accepting the detail data from purchaser, the analysis of non-conforming should be finished in two weeks.
 - (iii) If supplier can not finish analysis on time, must announce purchaser before 3 days.
 - b. Disposition of non-conforming:
 - (i) If find any product defect of supplier during assembly time, supplier must change the good product for every defect after recognition.
 - (ii) Both supplier and customer should analyze the reason and discuss the disposition of non-conforming when the reason of nonconforming is not sure.
- 11-4. Agreement items

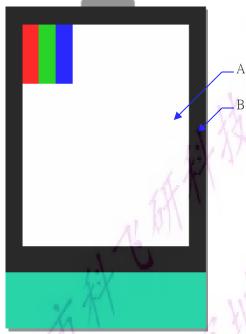
Both sides should discuss together when the following problems happen.

- a. There is any problem of standard of quality assurance, and both sides should think that must be modified.
- b. There is any argument item which does not record in the standard of quality assurance.
- c. Any other special problem.

- 11-5. Standard of The Product Appearance Test
 - a. Manner of appearance test:
 - (i) The test must be under 20W \times 2 or 40W fluorescent light, and the distance of view must be at 30 ± 5 cm.
 - (ii) When test the model of transmissive product must add the reflective plate.
 - (iii) The test direction is base on around 10° of vertical line.
 - (iiii) Temperature: 25±5℃ Humidity: 60±10%RH



(iv) Definition of area:



- A. Area: Viewing area.
- B. Area: Out of viewing area. (Outside viewing area)
- b. Basic principle:
 - (i) It will accord to the AQL when the standard can not be described.
- (ii) The sample of the lowest acceptable quality level must be discussed by both supplier and customer when any dispute happened.
- (iii) Must add new item on time when it is necessary.
- c. Standard of inspection: (Unit: mm)

11-6.	Inspection sp	ecification	
NO	Item	Criterion	AQL
01	Electrical Testing	1.1 Missing vertical, horizontal segment, segment contrast defect. 1.2 Missing character, dot or icon. 1.3 Display malfunction. 1.4 No function or no display. 1.5 Current consumption exceeds product specifications. 1.6 LCD viewing angle defect. 1.7 Mixed product types. 1.8 Flicker	0.65
02	Black or White spots or Bright spots or Color spots on LCD (Display only)	 2.1 White and black or color spots on display ≤ 0.25mm, no more than Five spots. 2.2 Densely spaced: No more than three spots within 3mm. 	2. 5
03	LCD and Touch Panel black spots, white	3.1 Round type: As following drawing $\Phi = (X+Y) / 2$ $\begin{array}{c ccccccccccccccccccccccccccccccccccc$	2. 5
	spots, contaminati on (non - display)	Length(m Width(mm) Acceptable Q'ty m)	2. 5

					AQL
04	Polarizer bubbles	If bubbles are visible, judge using black spot specifications, not easy to find, must check in specify direction	Size Φ (mm) $\Phi \le 0.20$ $0.20 < \Phi \le 0.50$ $0.50 < \Phi \le 1.00$ $1.00 < \Phi$ Total Q' ty	Acceptable Q'ty Accept no dense 3 2 0 3	2. 5
05	Scratches	Follow NO. 3 -2 Line Type.		Mr. I	
06	Chipped glass	<pre>Symbols: x: Chip length</pre>	between panels: $x: Chip leng$ $x: Chip leng$ $x \le 1/8a$	ength th Unit: mm of each chip	2. 5

NO	Item	Criterion	AQL
		Symbols: x: Chip length y: Chip width z: Chip thickness k: Seal width t: Glass thickness a: LCD side length L: Electrode pad length 7.2 Protrusion over terminal: 7.2.1 Chip on electrode pad:	3
		y: Chip width x: Chip z: Chip length thickness	N.
		$y \le 0.5 \text{mm} \qquad x \le 1/8 \text{a} \qquad 0 < z \le t$ 7.2.2 conductive portion:	
07	Glass crack	y $\uparrow z$ $\downarrow z$ $\downarrow z$ $\downarrow z$	2.5
		y: Chip width x: Chip z: Chip thickness	
		y≤L x≤1/8a 0< z≤t Of there chipped area touches the ITO terminal, over 2/3 of the ITO must remain and be inspected according to electrode terminal specifications. If the product will be heat sealed by the customer, the alignment mark must mot be damaged. Zeron versus and internal crack	
	***	y: width x: length	
		y ≤ 1/3L	

NO	Item	Criterion	AQL
08	Cracked glass	The LCD with extensive crack is not acceptable.	2.5
09	Backlight elements	9.1 Illumination source flickers when lit.9.2 Spots or scratches that appear when lit must be judged. Using LCD spot, lines and contamination standards.9.3 Backlight doesn't light or color is wrong.	2. 5 2. 5 0. 65
10	Bezel	Bezel must comply with product specifications.	2. 5
11	PCB、COB	 11.1 COB seal may not have pinholes larger than 0.2mm or contamination. 11.2 COB seal surface may not have pinholes through to the IC. 11.3 The height of the COB should not exceed the height indicated in the assembly diagram. 11.4 There may not be more than 2mm of sealant outside the seal area on PCB. And there should be no more than three places. 11.5 Parts on PCB must be the same as on the production characteristic chart, There should be no wrong parts, missing parts or excess parts. 11.6 The jumper on the PCB should conform to the product characteristic chart. 	2. 5 2. 5 2. 5 2. 5 0. 65
12	FPC	12.1 FPC terminal damage \leq 1/2 FPC terminal width and can not affect the function , we judge accept. 12.2 FPC alignment hole damage \leq 1/2 alignment area and can not affect the function , we judge accept.	2. 5 2. 5
13	Soldering	13.1 No cold solder joints, missing solder connections, oxidation or icicle. 13.2 No short circuits in components on PCB or FPC.	2. 5 0. 65

NO	Item	Criterion	AQL
		Symbols: x: Chip length y: Chip width z: Chip thickr k: Seal width t: Touch Panel Total thickness length L: Electrode pad length 14.1 General glass chip: 14.1.1 Chip on panel surface and crack between panels	a: LCD side
		X y k X X X X X X X X X X X X X X X X X	
		z: Chip thickness y: Chip width x: Chip le	ngth
14	Touch Panel Chipped glass		2. 5
	81033	⊙ If there are 2 or more chips, x is the total lengt 14.1.2 Corner crack:	ch of each chip
		z: Chip thickness y: Chip width x: Chip le	ngth
	* XIII	$\leq 1/2$ k and not over viewing area $x \leq 1/8$	a
31	*	○ Unit: mm○ If there are 2 or more chips, x is the total length	ch of each chip

NO	Item	Criterion	AQL
15	Touch Panel (Fi sh eye, dent and bubble on film)	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	2. 5
16	Touch Panel Newton ring	Newton ring dimension $\leq 1/2$ touch panel area and not affect font and line distortion($\leq 2.5\%$), it is acceptable.	2. 5
17	Touch Panel Linearit y	Less than 2.5% is acceptable.	2. 5
18	LCD Ripple	Touch the touch panel , can not see the LCD ripple. Pen: R 1.0mm silicon rubber. Operation Force: 80g	2. 5
19	General appearan ce	 19.1 Pin type must match type in specification sheet. 19.2 LCD pin loose or missing pins. 19.3 Product packaging must the same as specified on packaging specification sheet. 19.4 Product dimension and structure must conform to product specification sheet. 	0. 65 0. 65 0. 65 0. 65

12. General Precautions

12.1. Safety

Liquid crystal is poisonous. Do not put it in your mouth. If liquid crystal touches your skin or clothes, wash it off immediately by using soap and water.

12.2. Handling

- 1. The LCD panel is plate glass. Do not subject the panel to mechanical shock or to excessive force on its surface.
- 2. The polarizer attached to the display is easily damaged. Please handle it carefully to avoid scratch or other damages.
- 3. To avoid contamination on the display surface, do not touch the module surface with bare hands.
 - 4. Keep a space so that the LCD panels do not touch other components.
- 5. Put cover board such as acrylic board on the surface of LCD panel to protect panel from damages.
- 6. Transparent electrodes may be disconnected if you use the LCD panel under environmental conditions where the condensation of dew occurs.
 - 7. Do not leave module in direct sunlight to avoid malfunction of the ICs.

12.3. Static Electricity

- 1. Be sure to ground module before turning on power or operating module.
- 2. Do not apply voltage which exceeds the absolute maximum rating value.

12.4. Storage

- 1. Store the module in a dark room where must keep at $25\pm10^{\circ}$ C and 65%RH or less.
- 2. Do not store the module in surroundings containing organic solvent or corrosive gas.
- 3. Store the module in an anti-electrostatic container or bag.

12.5. Cleaning

- 1. Do not wipe the polarizer with dry cloth. It might cause scratch.
- 2. Only use a soft sloth with IPA to wipe the polarizer, other chemicals might permanent damage to the polarizer.

13. Packing method

----TBD